Unit: mm

TOSHIBA Field-Effect Transistor Silicon P-Channel MOS Type (U-MOSVI)

# SSM3J325F

○ Power Management Switch Applications

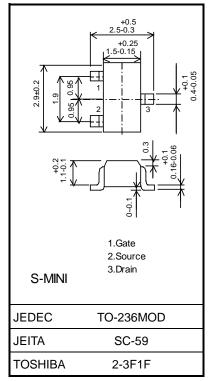
- 1.5-V drive
- Low ON-resistance: RDS(ON) = 311 mΩ (max) (@VGS = -1.5 V)
  - $R_{DS(ON)} = 231 \text{ m}\Omega \text{ (max)} (@V_{GS} = -1.8 \text{ V})$ 
    - $RDS(ON) = 179 \text{ m}\Omega \text{ (max)} (@VGS = -2.5 \text{ V})$

 $RDS(ON) = 150 \text{ m}\Omega \text{ (max)} (@VGS = -4.5 \text{ V})$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol		Rating	Unit	
Drain-source voltage		VDSS		-20	V	
Gate-source voltage		V <sub>GSS</sub>		± 8	V	
Drain current	DC	ID (Note 1)		-2.0	^	
	Pulse	IDP (Note 1)		-4.0	A	
Power dissipation		PD (Note 2)		600	mW	
			t = 1s	1200	TIIVV	
Channel temperature		T <sub>ch</sub>		150	°C	
Storage temperature range		T <sub>stg</sub>		-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



Weight: 12 mg (typ.)

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

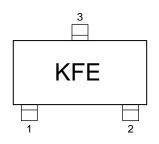
Note 1: The channel temperature should not exceed 150°C during use.

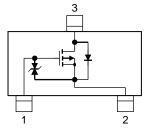
Note 2: Mounted on a FR4 board.

(25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm, Cu Pad: 645 mm<sup>2</sup>)

#### Marking

#### **Equivalent Circuit**





Start of commercial production 2010-01

**Electrical Characteristics (Ta = 25°C)** 

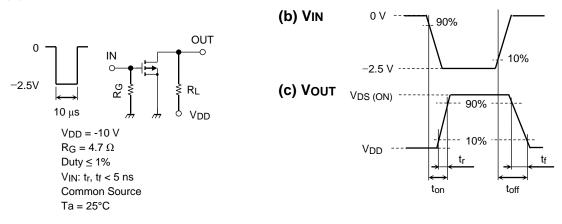
Chara	acteristic	Symbol	Test Conditions		Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	ID = -1 mA, VGS = 0 V		-20	—	—	V
		V (BR) DSX	I <sub>D</sub> = -1 mA, V <sub>GS</sub> = 5 V	(Note 4)	-15		_	V
Drain cut-off current		IDSS	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V		_		-1	μA
Gate leakage current		Igss	VGS = ±8 V, VDS = 0 V		_		±1	μA
Gate threshold voltage		Vth	V <sub>DS</sub> = -3 V, I <sub>D</sub> = -1 mA		-0.3	_	-1.0	V
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = -3 V, I <sub>D</sub> = -1.0 A	(Note 3)	2.2	4.4	—	S
Drain-source ON-resistance			ID = -1.0 A, VGS = -4.5 V	(Note 3)	_	123	150	mΩ
		Bag (a)	ID = -0.6 A, VGS = -2.5 V	(Note 3)	_	143	179	
		R <sub>DS</sub> (ON)	I <sub>D</sub> = -0.4 A, V <sub>GS</sub> = -1.8 V	(Note 3)	_	170	231	
			I <sub>D</sub> = -0.2 A, V <sub>GS</sub> = -1.5 V	(Note 3)	_	192	311	
Input capacitance		Ciss			_	270	—	
Output capacitance		C <sub>oss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V f = 1 MHz		_	40		pF
Reverse transfer capacitance		Crss			_	32		
Switching time	Turn-on time	ton	V <sub>DD</sub> = -10 V, I <sub>D</sub> = -1.0 A		_	17	—	
	Turn-off time	t <sub>off</sub>	VGS = 0 to -2.5 V, RG = 4.7 $\Omega$	!	_	43		ns
Total gate charge		Qg			_	4.6		
Gate-source charge		Qgs1	$V_{DD} = -10 V, I_{DD} = -2.0 A,$		_	0.4	_	nC
Gate-drain charge		Q <sub>gd</sub>	V <sub>GS</sub> = -4.5V		—	0.9	—	
Drain-source forward voltage		VDSF	I <sub>D</sub> = 2.0 A, V <sub>GS</sub> = 0 V	(Note 3)	_	0.97	1.2	V

Note 3: Pulse test

Note 4: If a forward bias is applied between gate and source, this device enters V(BR)DSX mode. Note that the drain-source breakdown voltage is lowered in this mode.

### Switching Time Test Circuit

#### (a) Test Circuit



#### Notice on Usage

Let Vth be the voltage applied between gate and source that causes the drain current (ID) to be low (-1 mA for the SSM3J325F). Then, for normal switching operation, VGS(on) must be higher than Vth, and VGS(off) must be lower than Vth. This relationship can be expressed as: VGS(off) < Vth < VGS(on).

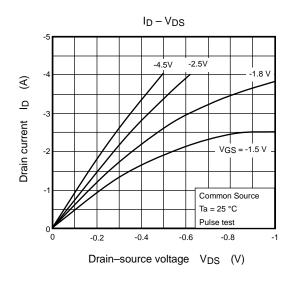
Take this into consideration when using the device.

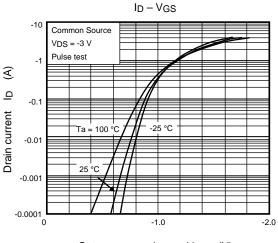
#### **Handling Precaution**

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

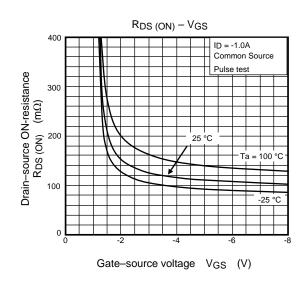
Thermal resistance R<sub>th</sub> (ch-a) and drain power dissipation P<sub>D</sub> vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration.

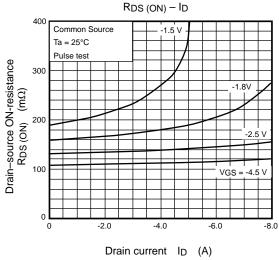
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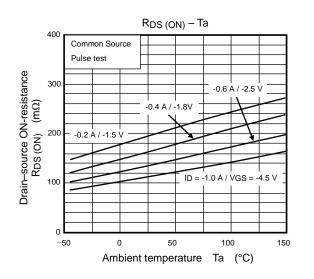




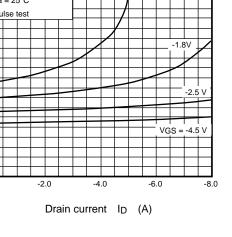
Gate-source voltage VGS (V)



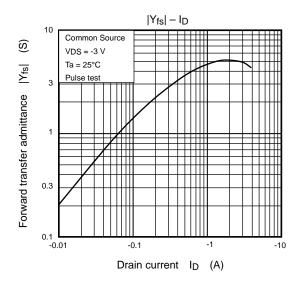


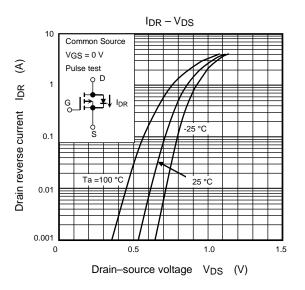


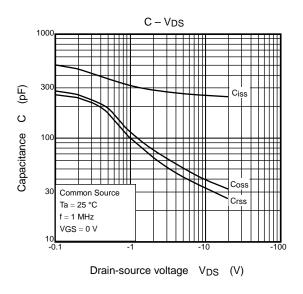
Vth – Ta -1.0 Common Source VDS = -3 V S ID = -1 mA Gate threshold voltage Vth -0.5 0 L -50 0 50 100 150 Ambient temperature Ta (°C)

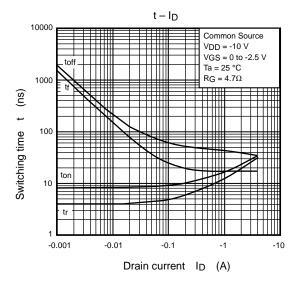


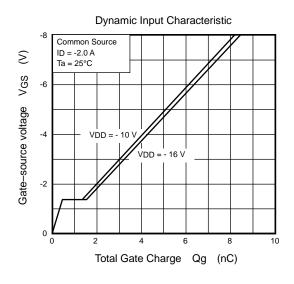
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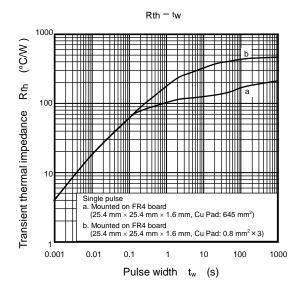


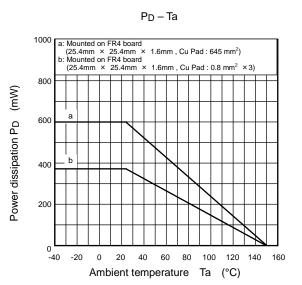






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